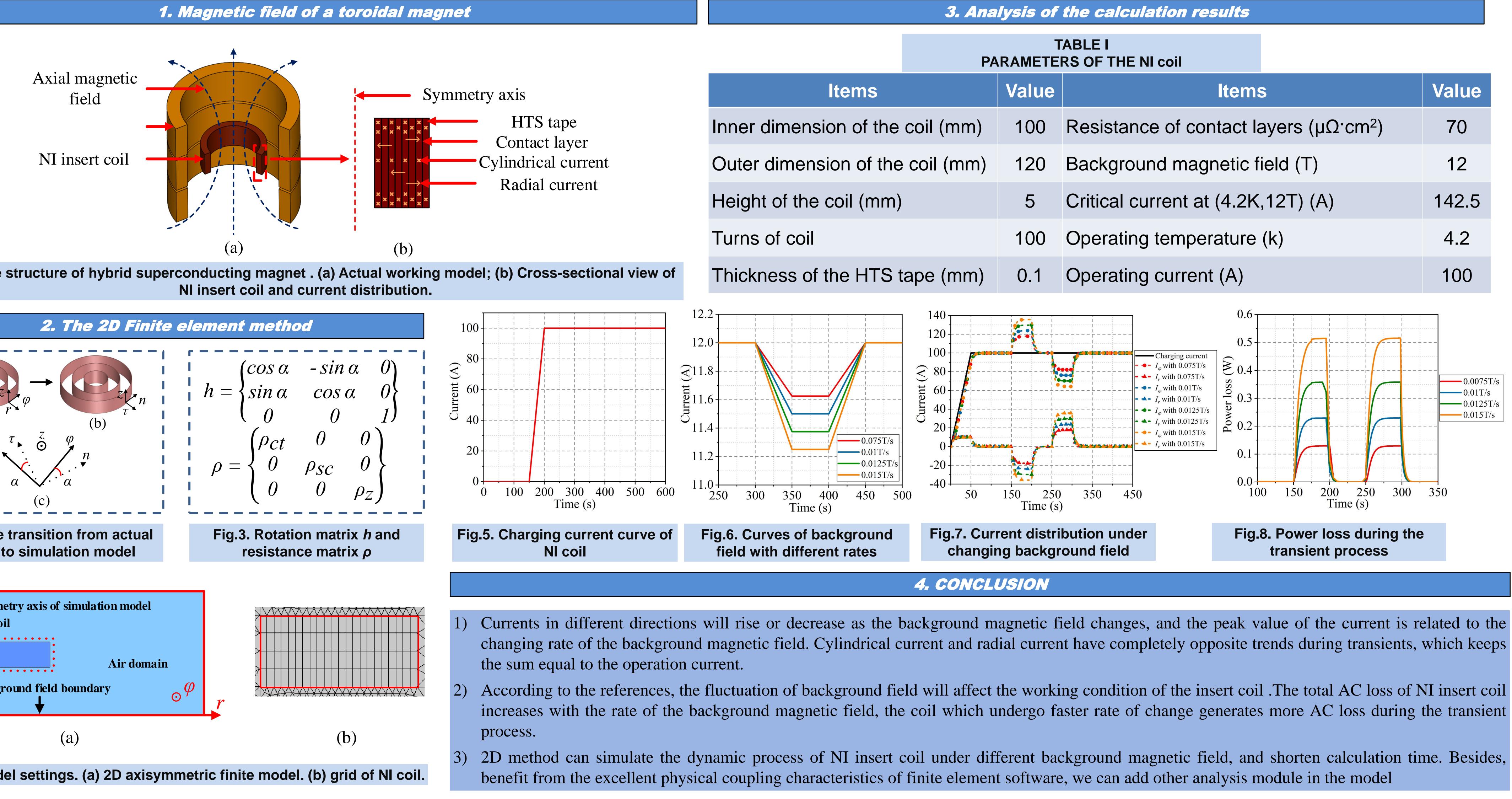
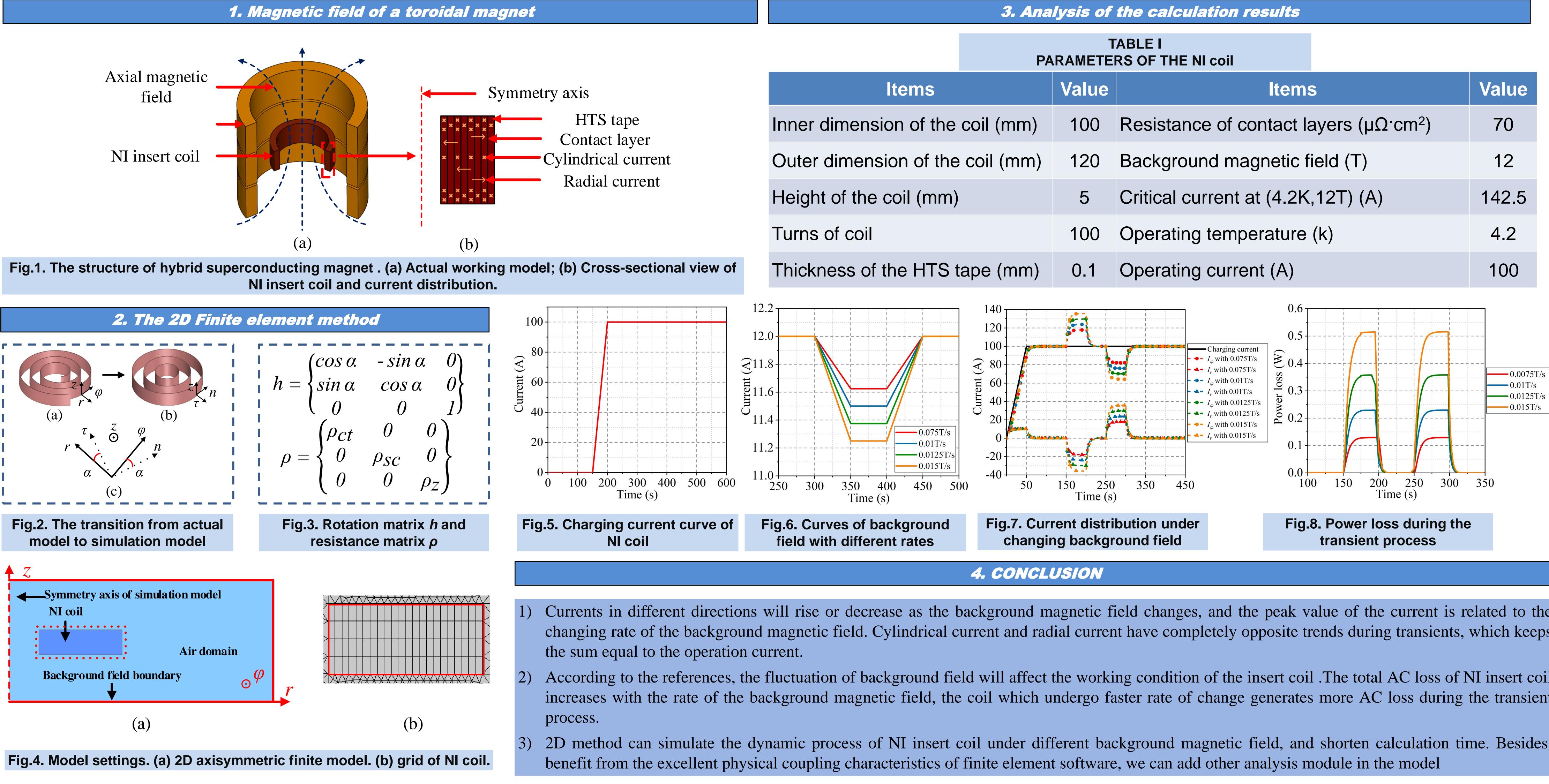


Abstract—Due to excellent thermal stability and high-power density in steady state, no-insulation (NI) winding technology is widely used in the application of superconducting magnets. However, current ripple and background magnetic field fluctuations caused by relative turn-to-turn current of the NI interpolated coil, which will impose a great impact on the thermal stability of NI magnet. This paper analyzes the power characteristics and other electromagnetic parameters of NI magnet under dynamic operating conditions by 2D finiteelement method. The results provide references of thermal conductive structure design and assessment of operational reliability of NI magnets in changing working conditions.





Thermal Stability Analysis of No-insulation Magnet under Dynamic Operational Conditions

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	adjudion
	calculation

	TABLE I PARAMETERS OF THE NI coil		
ltems		Value	
dimension of the coil (mm)		100	Resistance of c
dimension of the coil (mm)		120	Background ma
t of the coil (mm)		5	Critical current
of coil		100	Operating temp
ness of the HTS tape (mm)		0.1	Operating curre

